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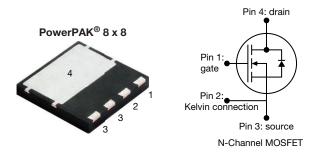
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.091				
Q _g max. (nC)	50				
Q _{gs} (nC)	16				
Q _{gd} (nC)	8	3			
Configuration	Sin	gle			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SIHH105N60EF-T1GE3

ABSOLUTE MAXIMUM RATINGS (To	= 25 °C, unless otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V_{DS}	600	V	
Gate-source voltage	V_{GS}	± 30	V	
Continuous drain current (T _{.1} = 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	- I _D	26	А
Continuous drain current (1) = 130 °C)	$T_C = 100 ^{\circ}$ C		17	
Pulsed drain current ^a	I _{DM}	59		
Linear derating factor			1.38	W/°C
Single pulse avalanche energy b		E _{AS}	127	mJ
Maximum power dissipation		P_{D}	174	W
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	dv/dt	100	V/ns	
Reverse diode dv/dt ^c		uv/ut	50	V/IIS

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_g = 25 \,\Omega$, $I_{AS} = 3.0 \,\text{A}$
- c. $I_{SD} \le I_D$, di/dt = 120 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	40	42	°C/W
Maximum junction-to-case (drain)	R _{thJC}	0.55	0.72	G/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					l		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.62	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Osta a superiori de la constanta de la constan		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	
Zana anta callana dusia accumant		V _{DS} =	: 480 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 13 A	-	0.091	0.105	Ω
Forward transconductance ^a	9 _{fs}	V_{DS}	= 10 V, I _D = 13 A	-	13	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	2099	-	
Output capacitance	C _{oss}	Ţ,	V _{DS} = 100 V,	-	87	-	
Reverse transfer capacitance	C _{rss}	1	f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	., .,	/+- 400 V V 0 V	-	65	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	V to 480 V, V _{GS} = 0 V	-	408	-	
Total gate charge	Qg			-	33	50	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$	-	16	-	nC
Gate-drain charge	Q _{gd}			-	8	-	
Turn-on delay time	t _{d(on)}			-	31	62	
Rise time	t _r	V _{DD} =	: 480 V, I _D = 13 A,	-	62	93	
Turn-off delay time	t _{d(off)}	V _{GS} =	$= 10 \text{ V, R}_{g} = 9.1 \Omega$	-	38	76	ns
Fall time	t _f	1		-	28	56	
Gate input resistance	R_g		f = 1 MHz	0.35	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym showing the		-	-	26	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	59	- A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 13 A, V _{GS} = 0 V	-	_	1.2	V
Reverse recovery time	t _{rr}			-	126	252	ns
Reverse recovery charge	Q _{rr}		$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 13 \text{A},$	-	0.6	1.2	μC
Reverse recovery current	I _{RRM}		100 A/ μ s, V _R = 25 V	_	9.4	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

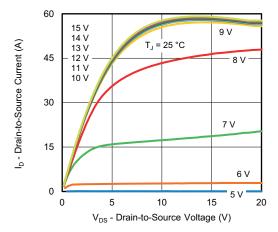


Fig. 1 - Typical Output Characteristics

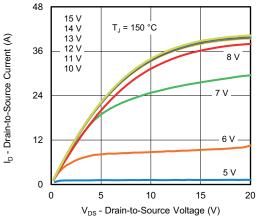


Fig. 2 - Typical Output Characteristics

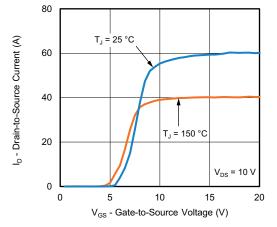


Fig. 3 - Typical Transfer Characteristics

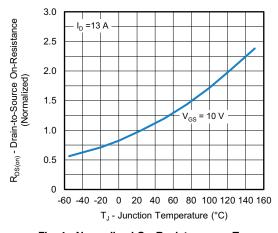


Fig. 4 - Normalized On-Resistance vs. Temperature

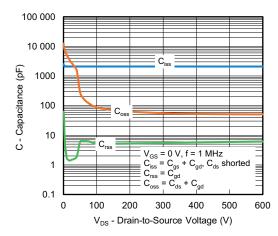


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

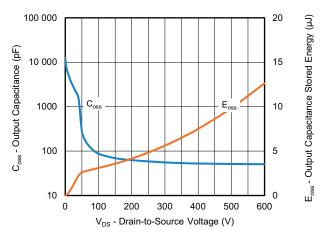


Fig. 6 - Coss and Eoss vs. VDS

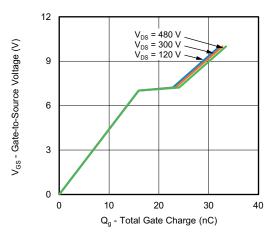


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

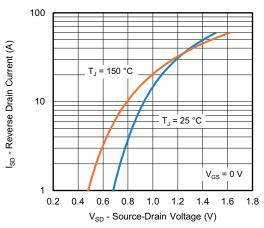


Fig. 8 - Typical Source-Drain Diode Forward Voltage

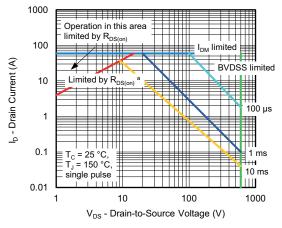


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

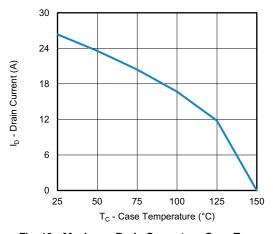


Fig. 10 - Maximum Drain Current vs. Case Temperature

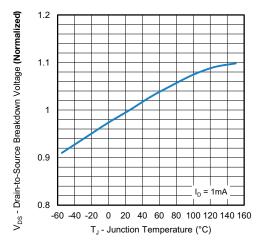


Fig. 11 - Temperature vs. Drain-to-Source Voltage



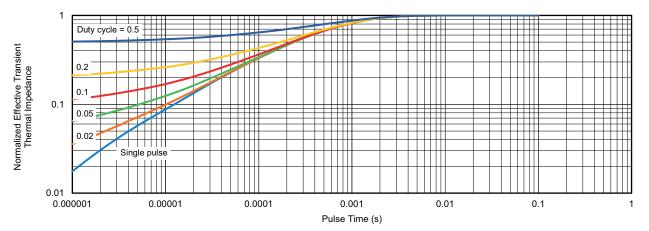


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

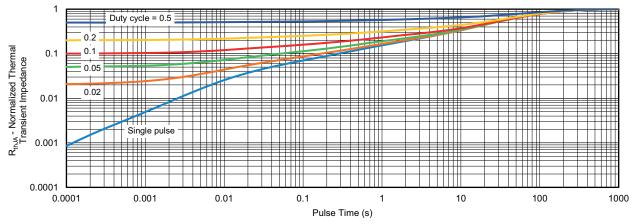


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

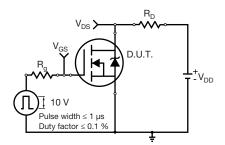


Fig. 14 - Switching Time Test Circuit

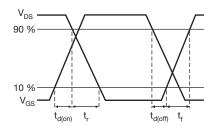


Fig. 15 - Switching Time Waveforms

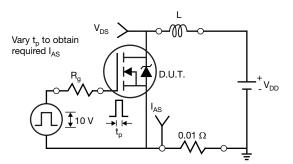


Fig. 16 - Unclamped Inductive Test Circuit

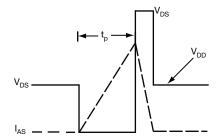


Fig. 17 - Unclamped Inductive Waveforms

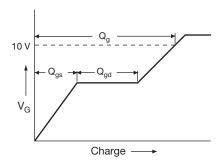


Fig. 18 - Basic Gate Charge Waveform

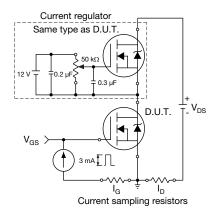
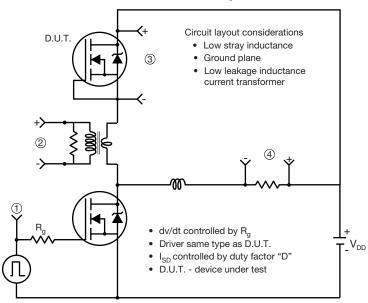


Fig. 19 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



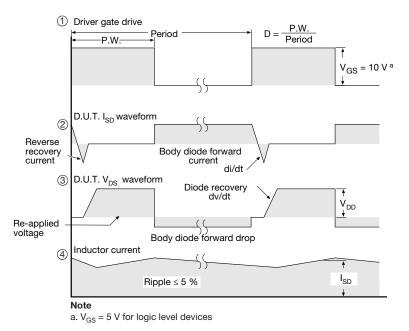


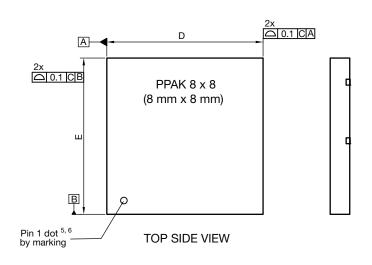
Fig. 20 - For N-Channel

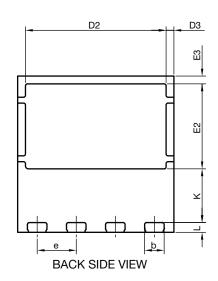
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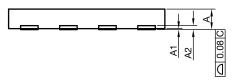


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PowerPAK® 8 x 8 Case Outline







DIM.	MILLIMETERS		INCHES			
DIIVI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.95	1.00	1.05	0.037	0.039	0.041
A1	0.00	-	0.05	0.000	-	0.002
A2	020 ref.				0.008 ref.	
b	0.95	1.00	1.05	0.037	0.039	0.041
D	7.90	8.00	8.10	0.311	0.315	0.319
D2	7.10	7.20	7.30	0.280	0.283	0.287
D3	0.40 BSC			0.016 BSC		
е	2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319
E2	4.30	4.35	4.40	0.169	0.171	0.173
E3	0.40 BSC				0.016 BSC	
K	2.75 BSC		0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022
N ⁽³⁾	8				8	

Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

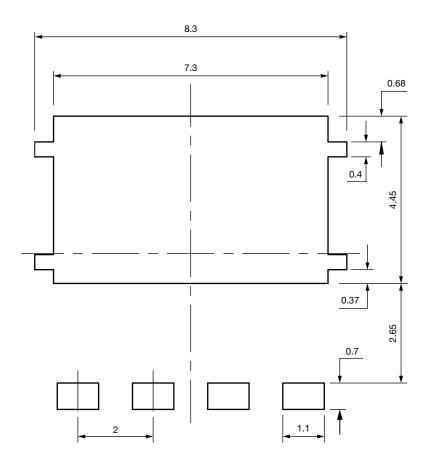
ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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